

3 1/2 Digit LCD, A/D Converter with Overage Recovery

The Intersil HT7126A is a high performance, low power $3\frac{1}{2}$ digit, A/D converter. Included are seven segment decoders, display drivers, a reference, and a clock. The HT7126A is designed to interface with a liquid crystal display (LCD) and includes a multiplexed backplane drive.

The HT7126A brings together a combination of high accuracy, versatility, and true economy. It features auto-zero to less than $10\mu\text{V}$, zero drift of less than $1\mu\text{V}/^\circ\text{C}$, input bias current of 10pA (Max), and rollover error of less than one count. True differential inputs and reference are useful in all systems, but give the designer an uncommon advantage when measuring load cells, strain gauges and other bridge type transducers. Finally, the true economy of single power supply operation, enables a high performance panel meter to be built with the addition of only 10 passive components and a display.

The HT7126A is an improved version of the ICL7126, eliminating the overrange hangover and hysteresis effects, and should be used in its place in all applications. It can also be used as a plug-in replacement for the ICL7106 in a wide variety of applications, changing only the passive components.

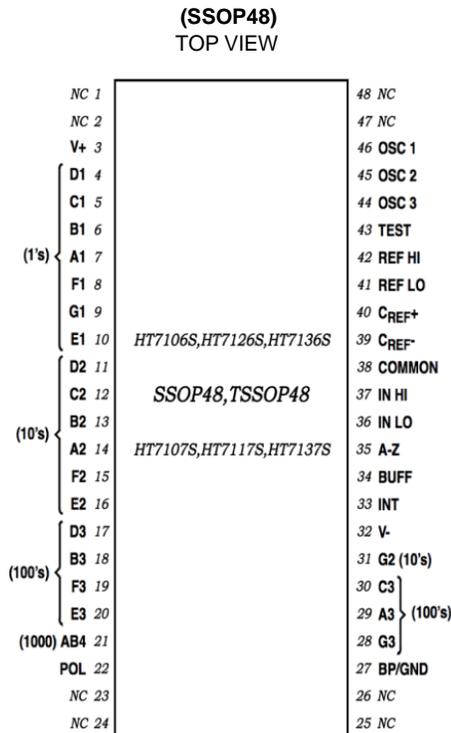
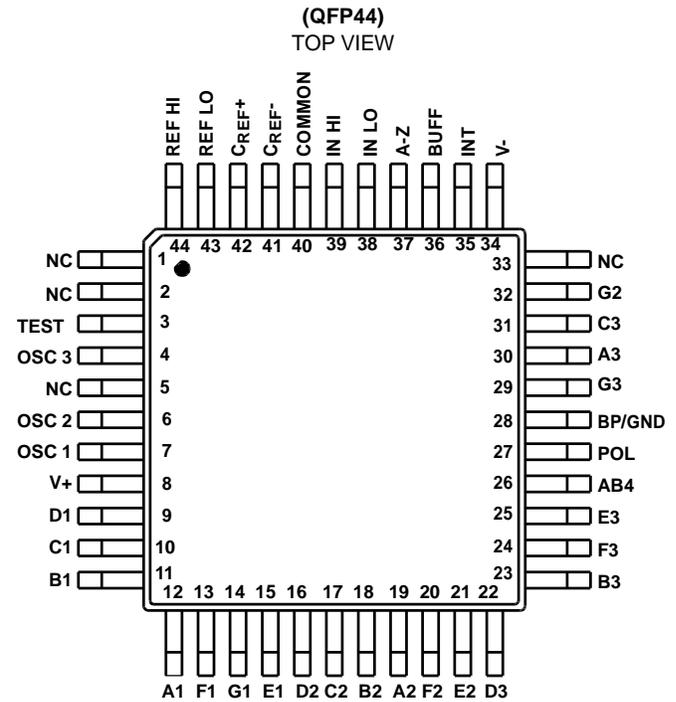
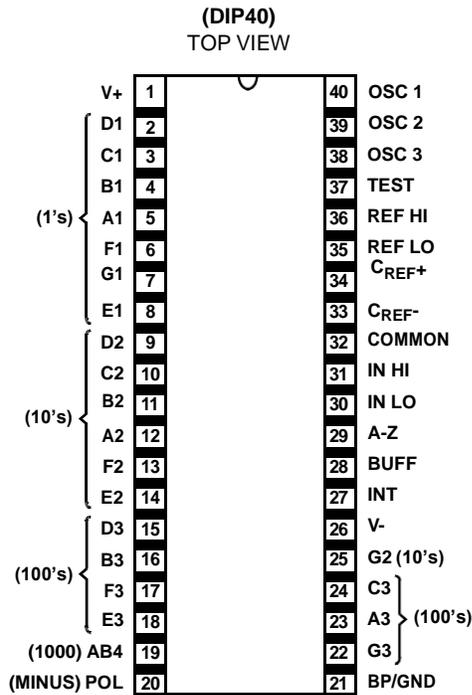
Features

- First Reading Overage Recovery in One Conversion Period
- Guaranteed Zero Reading for 0V Input on All Scales
- True Polarity at Zero for Precise Null Detection
- 1pA Typical Input Current
- True Differential Input and Reference, Direct Display Drive - LCD HT7126A
- Low Noise - Less Than $15\mu\text{V}_{\text{P-P}}$
- On Chip Clock and Reference
- No Additional Active Circuits Required
- Low Power - Less Than 1mW
- Surface Mount Package Available
- Drop-In Replacement for ICL7126, No Changes Needed
- Pb-Free Plus Anneal Available (RoHS Compliant)

Ordering Information

HT7126ANZ	DIP40
HT7126ARQZ	LQFP44(10*10)
HT7126ARSZ	SSOP48

$T_A = -45^\circ$ to 85° C for all packages

Pinouts


Absolute Maximum Ratings

Supply Voltage	
HT7126A, V+ to V-	15V
Analog Input Voltage (Either Input) (Note 1)	V+ to V-
Reference Input Voltage (Either Input)	V+ to V-
Clock Input	
HT7126A	TEST to V+

Operating Conditions

Temperature Range	0°C to 70°C
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Thermal Information

Thermal Resistance (Typical, Note 2)	θ_{JA} (°C/W)
PDIP Package*	50
MQFP Package	75
Maximum Junction Temperature	150°C
Maximum Storage Temperature Range	-65°C to 150°C
Maximum Lead Temperature (Soldering 10s)	300°C (MQFP - Lead Tips Only)

*Pb-free PDIPs can be used for through hole wave solder processing only. They are not intended for use in Reflow solder processing applications.

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES:

1. Input voltages may exceed the supply voltages provided the input current is limited to $\pm 100\mu\text{A}$.
2. θ_{JA} is measured with the component mounted on a low effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

Electrical Specifications (Note 3)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
SYSTEM PERFORMANCE					
Zero Input Reading	$V_{IN} = 0V$, Full Scale = 200mV	-000.0	± 000.0	+000.0	Digital Reading
Ratiometric Reading	$V_{IN} = V_{REF}$, $V_{REF} = 100mV$	999	999/ 1000	1000	Digital Reading
Rollover Error	$-V_{IN} = +V_{IN} \cong 200mV$ Difference in Reading for Equal Positive and Negative Inputs Near Full Scale	-	± 0.2	± 1	Counts
Linearity	Full Scale = 200mV or Full Scale = 2V Maximum Deviation from Best Straight Line Fit (Note 5)	-	± 0.2	± 1	Counts
Common Mode Rejection Ratio	$V_{CM} = \pm 1V$, $V_{IN} = 0V$, Full Scale = 200mV (Note 5)	-	50	-	$\mu\text{V}/V$
Noise	$V_{IN} = 0V$, Full Scale = 200mV (Peak-To-Peak Value Not Exceeded 95% of Time) (Note 5)	-	15	-	μV
Leakage Current Input	$V_{IN} = 0V$ (Note 5)	-	1	10	pA
Zero Reading Drift	$V_{IN} = 0V$, 0°C To 70°C (Note 5)	-	0.2	1	$\mu\text{V}/^\circ\text{C}$
Scale Factor Temperature Coefficient	$V_{IN} = 199mV$, 0°C To 70°C, (Ext. Ref. 0ppm/ $^\circ\text{C}$) (Note 5)	-	1	5	ppm/ $^\circ\text{C}$
COMMON Pin Analog Common Voltage	25k Ω Between Common and Positive Supply (With Respect to + Supply)	2.4	3.0	3.2	V
Temperature Coefficient of Analog Common	25k Ω Between Common and Positive Supply (With Respect to + Supply) (Note 5)	-	150	-	ppm/ $^\circ\text{C}$
SUPPLY CURRENT					
V+ Supply Current	$V_{IN} = 0$ (Does Not Include Common Current) 16kHz Oscillator (Note 6)	-	70	100	μA
DISPLAY DRIVER					
Peak-To-Peak Segment Drive Voltage and Peak-To-Peak Backplane Drive Voltage	V+ to V- = 9V (Note 4)	4	5.5	6	V

NOTES:

3. Unless otherwise noted, specifications apply to the HT7126A at $T_A = 25^\circ\text{C}$, $f_{CLOCK} = 48\text{kHz}$. HT7126A is tested in the circuit of Figure 1.
4. Back plane drive is in phase with segment drive for "off" segment, 180 degrees out of phase for "on" segment. Frequency is 20 times conversion rate. Average DC component is less than 50mV.
5. Not tested, guaranteed by design.
6. 48kHz oscillator increases current by 20 μA (Typ).

Typical Applications and Test Circuits

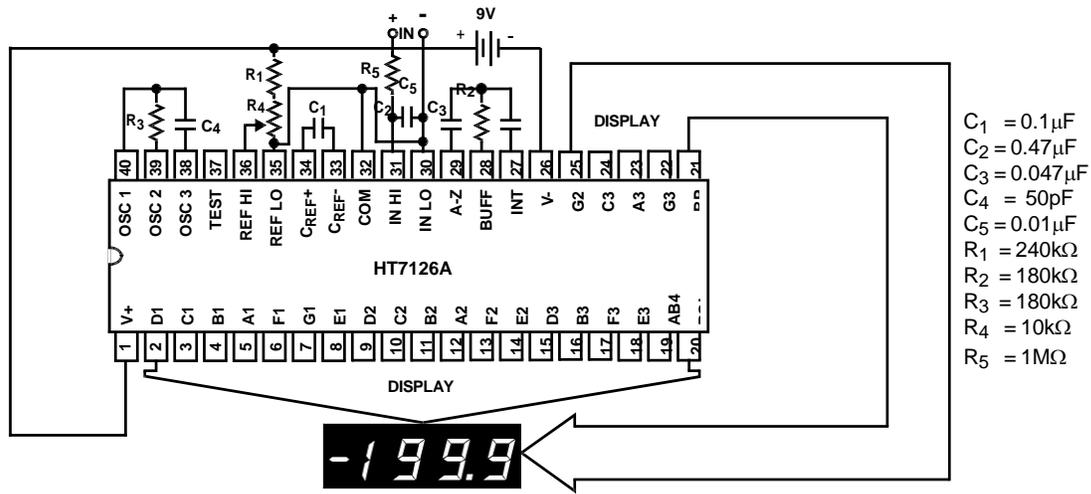


FIGURE 1. HT7126A TEST CIRCUIT AND TYPICAL APPLICATION WITH LCD DISPLAY COMPONENTS SELECTED FOR 200mV FULL SCALE

Design Information Summary Sheet
• OSCILLATOR FREQUENCY

$$f_{OSC} = 0.45/RC$$

$$C_{OSC} > 50pF; R_{OSC} > 50k\Omega$$

$$f_{OSC} (Typ) = 48kHz$$

• OSCILLATOR PERIOD

$$t_{OSC} = RC/0.45$$

• INTEGRATION CLOCK FREQUENCY

$$f_{CLOCK} = f_{OSC}/4$$

• INTEGRATION PERIOD

$$t_{INT} = 1000 \times (4/f_{OSC})$$

• 60/50Hz REJECTION CRITERION

$$t_{INT}/t_{60Hz} \text{ or } t_{INT}/t_{50Hz} = \text{Integer}$$

• OPTIMUM INTEGRATION CURRENT

$$I_{INT} = 1\mu A$$

• FULL SCALE ANALOG INPUT VOLTAGE

$$V_{INFS} (Typ) = 200mV \text{ or } 2V$$

• INTEGRATE RESISTOR

$$R_{INT} = \frac{V_{INFS}}{I_{INT}}$$

• INTEGRATE CAPACITOR

$$C_{INT} = \frac{(t_{INT} \times I_{INT})}{V_{INT}}$$

• INTEGRATOR OUTPUT VOLTAGE SWING

$$V_{INT} = \frac{(t_{INT})(I_{INT})}{C_{INT}}$$

• V_{INT} MAXIMUM SWING:

$$(V- + 0.5V) < V_{INT} < (V+ - 0.5V), V_{INT} (Typ) = 2V$$

• DISPLAY COUNT

$$COUNT = 1000 \times \sqrt{\frac{V_{IN}}{REF}}$$

• CONVERSION CYCLE

$$t_{CYC} = t_{CLOCK} \times 4000$$

$$t_{CYC} = t_{OSC} \times 16,000$$

when $f_{OSC} = 48kHz$; $t_{CYC} = 333ms$

• COMMON MODE INPUT VOLTAGE

$$(V- + 1V) < V_{IN} < (V+ - 0.5V)$$

• AUTO-ZERO CAPACITOR

$$0.01\mu F < C_{AZ} < 1\mu F$$

• REFERENCE CAPACITOR

$$0.1\mu F < C_{REF} < 1\mu F$$

• V_{COM}

Biased between $V+$ and $V-$.

• $V_{COM} \cong V+ - 2.8V$

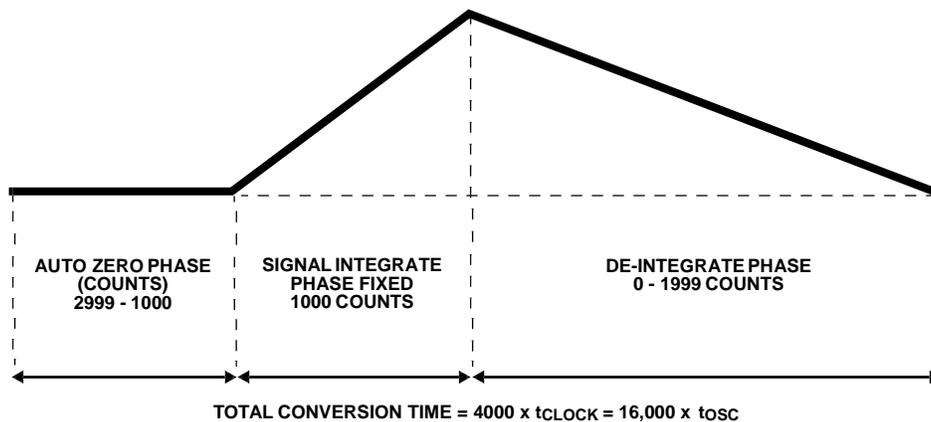
Regulation lost when $V+$ to $V- \leq 6.8V$.
 If V_{COM} is externally pulled down to $(V+ + V-)/2$, the V_{COM} circuit will turn off.

• POWER SUPPLY: SINGLE 9V

$V+ - V- = 9V$
 Digital supply is generated internally
 $V_{TEST} \cong V+ - 4.5V$

• DISPLAY: LCD

Type: Direct drive with digital logic supply amplitude.

Typical Integrator Amplifier Output Waveform (INT Pin)


Pin Descriptions

PIN NUMBER		NAME	FUNCTION	DESCRIPTION
40 PIN DIP	44 PIN FLATPACK			
1	8	V+	Supply	Power Supply.
2	9	D1	Output	Driver Pin for Segment "D" of the display units digit.
3	10	C1	Output	Driver Pin for Segment "C" of the display units digit.
4	11	B1	Output	Driver Pin for Segment "B" of the display units digit.
5	12	A1	Output	Driver Pin for Segment "A" of the display units digit.
6	13	F1	Output	Driver Pin for Segment "F" of the display units digit.
7	14	G1	Output	Driver Pin for Segment "G" of the display units digit.
8	15	E1	Output	Driver Pin for Segment "E" of the display units digit.
9	16	D2	Output	Driver Pin for Segment "D" of the display tens digit.
10	17	C2	Output	Driver Pin for Segment "C" of the display tens digit.
11	18	B2	Output	Driver Pin for Segment "B" of the display tens digit.
12	19	A2	Output	Driver Pin for Segment "A" of the display tens digit.
13	20	F2	Output	Driver Pin for Segment "F" of the display tens digit.
14	21	E2	Output	Driver Pin for Segment "E" of the display tens digit.
15	22	D3	Output	Driver pin for segment "D" of the display hundreds digit.
16	23	B3	Output	Driver pin for segment "B" of the display hundreds digit.
17	24	F3	Output	Driver pin for segment "F" of the display hundreds digit.
18	25	E3	Output	Driver pin for segment "E" of the display hundreds digit.
19	26	AB4	Output	Driver pin for both "A" and "B" segments of the display thousands digit.
20	27	POL	Output	Driver pin for the negative sign of the display.
21	28	BP/GND	Output	Driver pin for the LCD backplane/Power Supply Ground.
22	29	G3	Output	Driver pin for segment "G" of the display hundreds digit.
23	30	A3	Output	Driver pin for segment "A" of the display hundreds digit.
24	31	C3	Output	Driver pin for segment "C" of the display hundreds digit.
25	32	G2	Output	Driver pin for segment "G" of the display tens digit.
26	34	V-	Supply	Negative power supply.
27	35	INT	Output	Integrator amplifier output. To be connected to integrating capacitor.
28	36	BUFF	Output	Input buffer amplifier output. To be connected to integrating resistor.
29	37	A-Z	Input	Integrator amplifier input. To be connected to auto-zero capacitor.
30	38	IN LO	Input	Differential inputs. To be connected to input voltage to be measured. LO and HI designators are for reference and do not imply that LO should be connected to lower potential, e.g., for negative inputs IN LO has a higher potential than IN HI.
31	39	IN HI	Input	
32	40	COMMON	Supply/Output	Internal voltage reference output.
33	41	C _{REF-}		Connection pins for reference capacitor.
34	42	C _{REF+}		
35	43	REF LO	Input	Input pins for reference voltage to the device. REF HI should be positive reference to REF LO.
36	44	REF HI	Input	
37	3	TEST	Input	Display test. Turns on all segments when tied to V+.
38	4	OSC3	Output	Device clock generator circuit connection pins.
39	6	OSC2	Output	
40	7	OSC1	Input	

Detailed Description

Analog Section

Figure 2 shows the Analog Section for the HT7126A. Each measurement cycle is divided into four phases. They are (1) auto-zero (A-Z), (2) signal integrate (INT) and (3) de-integrate (DE), (4) zero integrate (ZI).

Auto-Zero Phase

During auto-zero three things happen. First, input high and low are disconnected from the pins and internally shorted to analog

COMMON. Second, the reference capacitor is charged to the reference voltage. Third, a feedback loop is closed around the system to charge the auto-zero capacitor C_{AZ} to compensate for offset voltages in the buffer amplifier, integrator, and comparator. Since the comparator is included in the loop, the A-Z accuracy is limited only by the noise of the system. In any case, the offset referred to the input is less than 10 μ V.

Signal Integrate Phase

During signal integrate, the auto-zero loop is opened, the internal short is removed, and the internal input high and low

Analog COMMON

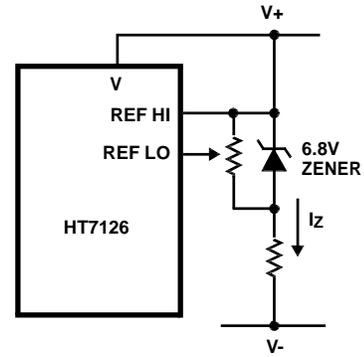
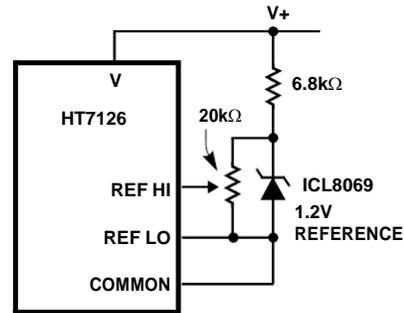
This pin is included primarily to set the common mode voltage for battery operation or for any system where the input signals are floating with respect to the power supply. The COMMON pin sets a voltage that is approximately 2.8V more negative than the positive supply. This is selected to give a minimum end-of-life battery voltage of about 6.8V. However, analog COMMON has some of the attributes of a reference voltage. When the total supply voltage is large enough to cause the zener to regulate ($>7V$), the COMMON voltage will have a low voltage coefficient ($0.001\%/V$), low output impedance ($\cong 15\Omega$), and a temperature coefficient typically less than $150\text{ppm}/^\circ\text{C}$.

The limitations of the on chip reference should also be recognized, however. Due to their higher thermal resistance, plastic parts are poorer in this respect than ceramic. The combination of reference Temperature Coefficient (TC), internal chip dissipation, and package thermal resistance can increase noise near full scale from $25\mu\text{V}$ to $80\mu\text{V}_{\text{P-P}}$. Also the linearity in going from a high dissipation count such as 1000 (20 segments on) to a low dissipation count such as 1111 (8 segments on) can suffer by a count or more. Devices with a positive TC reference may require several counts to pull out of an over range condition. This is because over-range is a low dissipation mode, with the three least significant digits blanked. Similarly, units with a negative TC may cycle between over range and a non-over range count as the die alternately heats and cools. All these problems are of course eliminated if an external reference is used.

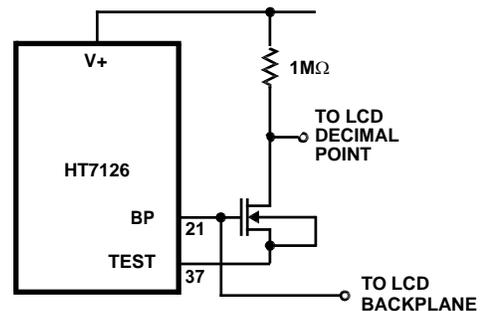
The HT7126A, with its negligible dissipation, suffers from none of these problems. In either case, an external reference can easily be added, as shown in Figure 3.

Analog COMMON is also used as the input low return during auto-zero and de-integrate. If IN LO is different from analog COMMON, a common mode voltage exists in the system and is taken care of by the excellent CMRR of the converter. However, in some applications IN LO will be set at a fixed known voltage (power supply common for instance). In this application, analog COMMON should be tied to the same point, thus removing the common mode voltage from the converter. The same holds true for the reference voltage. If reference can be conveniently tied to analog COMMON, it should be since this removes the common mode voltage from the reference system.

Within the IC, analog COMMON is tied to an N-Channel FET that can sink approximately 3mA of current to hold the voltage 2.8V below the positive supply (when a load is trying to pull the common line positive). However, there is only $10\mu\text{A}$ of source current, so COMMON may easily be tied to a more negative voltage thus overriding the internal reference.


FIGURE 3A.

FIGURE 3B.
FIGURE 3. USING AN EXTERNAL REFERENCE
TEST

The TEST pin serves two functions. On the HT7126A it is coupled to the internally generated digital supply through a 500Ω resistor. Thus it can be used as the negative supply for externally generated segment drivers such as decimal points or any other presentation the user may want to include on the LCD display. Figures 4 and 5 show such an application. No more than a 1mA load should be applied.


FIGURE 4. SIMPLE INVERTER FOR FIXED DECIMAL POINT

The second function is a "lamp test". When TEST is pulled high (to $V+$) all segments will be turned on and the display should read "-1888". The TEST pin will sink about 5mA under these conditions.

CAUTION: On the HT7126A, in the lamp test mode, the segments have a constant DC voltage (no square-wave) and may burn the LCD display if left in this mode for several minutes.

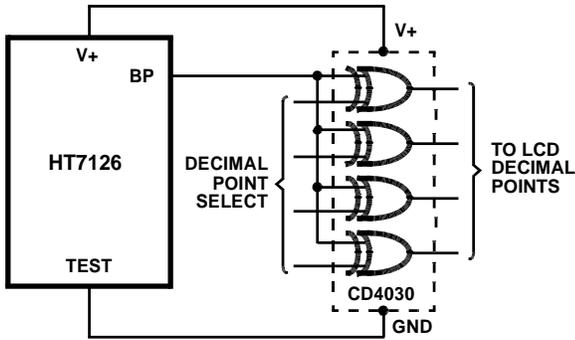


FIGURE 5. EXCLUSIVE "OR" GATE FOR DECIMAL POINT DRIVE

Digital Section

Figure 6 shows the digital section for the HT7126A. In the HT7126A, an internal digital ground is generated from a 6V Zener diode and a large P-Channel source follower. This supply is made stiff to absorb the relatively large capacitive currents when the back plane (BP) voltage is switched. The BP frequency is the clock frequency divided by 800. For three readings/second this is a 60Hz square wave with a nominal amplitude of 5V. The segments are driven at the same frequency and amplitude and are in phase with BP when OFF, but out of phase when ON. In all cases negligible DC voltage exists across thesegments.

The polarity indication is "on" for negative analog inputs. If IN LO and IN HI are reversed, this indication can be reversed also, if desired.

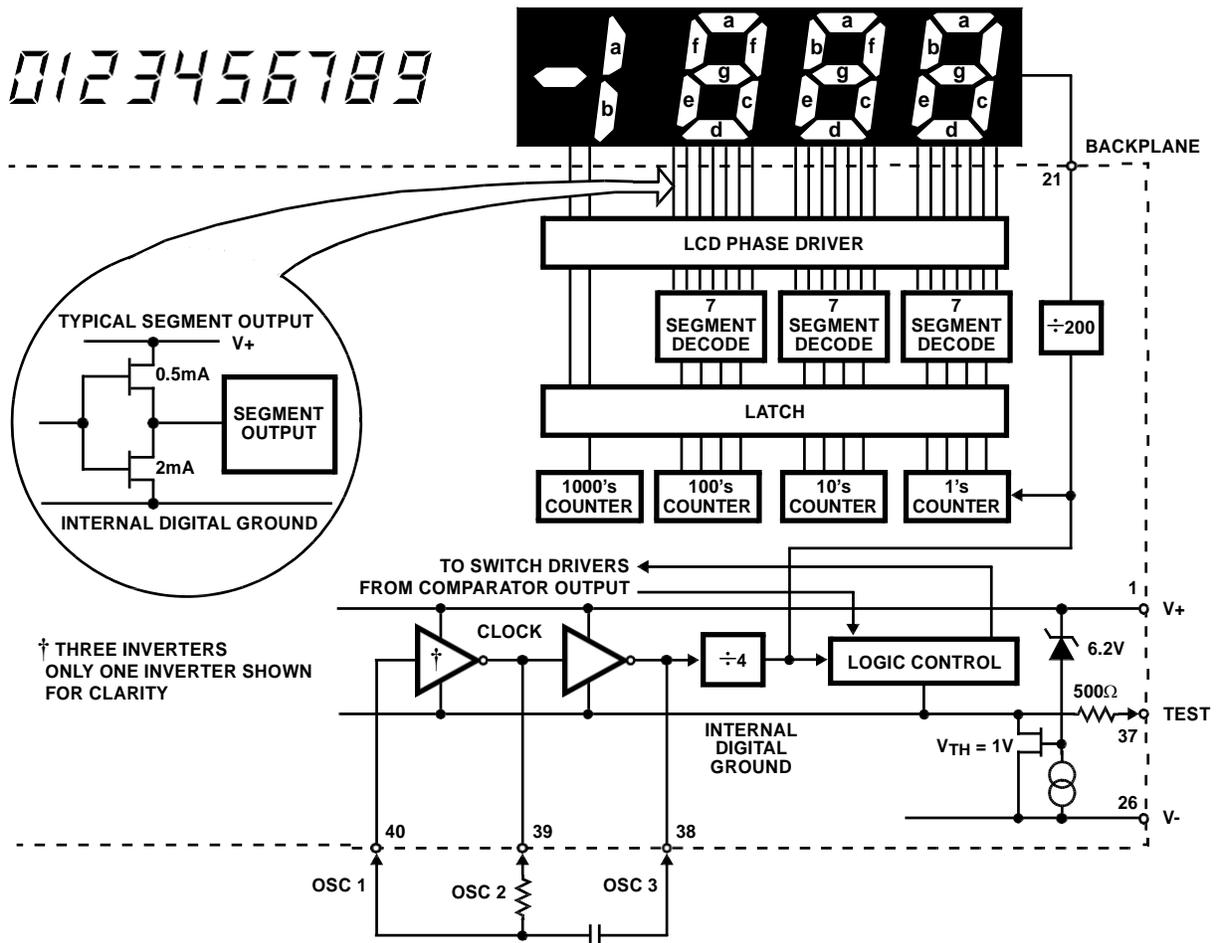


FIGURE 6. HT7126A DIGITAL SECTION

System Timing

Figure 7 shows the clocking arrangement used in the HT7126A. Two basic clocking arrangements can be used:

1. Figure 9A, an external oscillator connected to DIP pin 40.
2. Figure 9B, an R-C oscillator using all three pins.

The oscillator frequency is divided by four before it clocks the decade counters. It is then further divided to form the three convert-cycle phases. These are signal integrate (1000 counts), reference de-integrate (0 to 2000 counts) and auto-zero (1000 to 3000 counts). For signals less than full scale, auto-zero gets the unused portion of reference de-integrate. This makes a complete measure cycle of 4,000 counts (16,000 clock pulses) independent of input voltage. For three readings/second, an oscillator frequency of 48kHz would be used.

To achieve maximum rejection of 60Hz pickup, the signal integrate cycle should be a multiple of 60Hz. Oscillator frequencies of 240kHz, 120kHz, 80kHz, 60kHz, 48kHz, 40kHz, $33\frac{1}{3}$ kHz, etc., should be selected. For 50Hz rejection, Oscillator frequencies of 200kHz, 100kHz, $66\frac{2}{3}$ kHz, 50kHz, 40kHz, etc. would be suitable. Note that 40kHz (2.5 readings/sec.) will reject both 50Hz and 60Hz (also 400Hz and 440Hz).

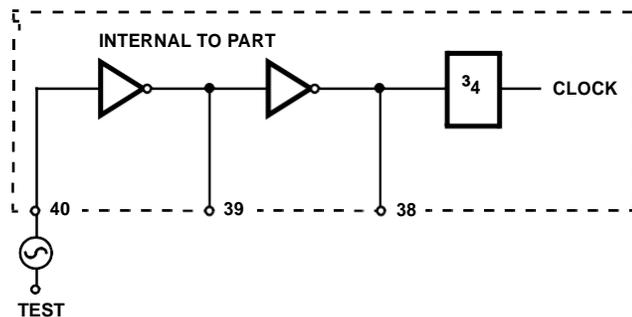


FIGURE 7A. EXTERNAL OSCILLATOR

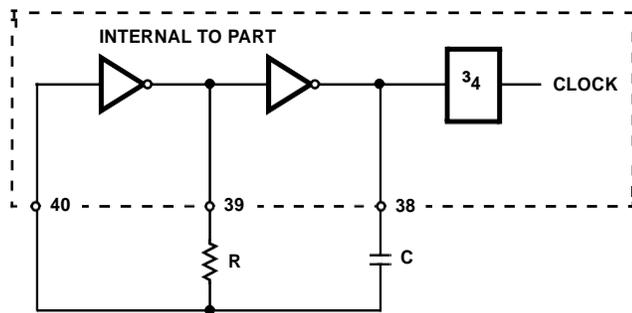


FIGURE 7B. RC OSCILLATOR
 FIGURE 7. CLOCK CIRCUITS

Component Value Selection

Integrating Resistor

Both the buffer amplifier and the integrator have a class A output stage with 100μA of quiescent current. They can supply 1μA of drive current with negligible nonlinearity. The integrating resistor should be large enough to remain in this very linear region over the input voltage range, but small enough that undue leakage requirements are not placed on the PC board. For 2V full scale, 1.8MΩ is near optimum and similarly a 180kΩ for a 200mV scale.

Integrating Capacitor

The integrating capacitor should be selected to give the maximum voltage swing that ensures tolerance buildup will not saturate the integrator swing (approximately 0.3V from either supply). In the HT7126A, when the analog COMMON is used as a reference, a nominal +2V full-scale integrator swing is fine. For three readings/second (48kHz clock) nominal values for C_{INT} are 0.047μF and 0.5μF, respectively. Of course, if different oscillator frequencies are used, these values should be changed in inverse proportion to maintain the same output swing.

An additional requirement of the integrating capacitor is that it must have a low dielectric absorption to prevent roll-over errors. While other types of capacitors are adequate for this application, polypropylene capacitors give undetectable errors at reasonable cost.

Auto-Zero Capacitor

The size of the auto-zero capacitor has some influence on the noise of the system. For 200mV full scale where noise is very important, a 0.47μF capacitor is recommended. On the 2V scale, a 0.047μF capacitor increases the speed of recovery from overload and is adequate for noise on this scale.

Reference Capacitor

A 0.1μF capacitor gives good results in most applications. However, where a large common mode voltage exists (i.e., the REF LO pin is not at analog COMMON) and a 200mV scale is used, a larger value is required to prevent roll-over error. Generally 1μF will hold the roll-over error to 0.5 count in this instance.

Oscillator Components

For all ranges of frequency a 180kΩ resistor is recommended and the capacitor is selected from the equation:

$$f = \frac{0.45}{RC} \text{ For 48kHz Clock (3 Readings/s.),}$$

$$C = 50\text{pF.}$$

Reference Voltage

The analog input required to generate full scale output (2000 counts) is: $V_{IN} = 2V_{REF}$. Thus, for the 200mV and 2V scale, V_{REF} should equal 100mV and 1V, respectively. However, in many applications where the A/D is connected to a transducer, there will exist a scale factor other than unity between the input voltage and the digital reading. For instance, in a weighing system, the designer might like to have a full scale reading when the voltage from the transducer is 0.662V. Instead of dividing the input down to 200mV, the designer should use the input voltage directly and select $V_{REF} = 0.341V$. Suitable values for integrating resistor and capacitor would be 330k Ω and 0.047 μF . This makes the system slightly quieter and also avoids a divider network on the input. Another advantage of this system occurs when a digital reading of zero is desired for $V_{IN} \neq 0$. Temperature and weighing systems with a variable fare are examples. This offset reading can be conveniently generated by connecting the voltage transducer between IN HI and COMMON and the variable (or fixed) offset voltage between COMMON and IN LO.

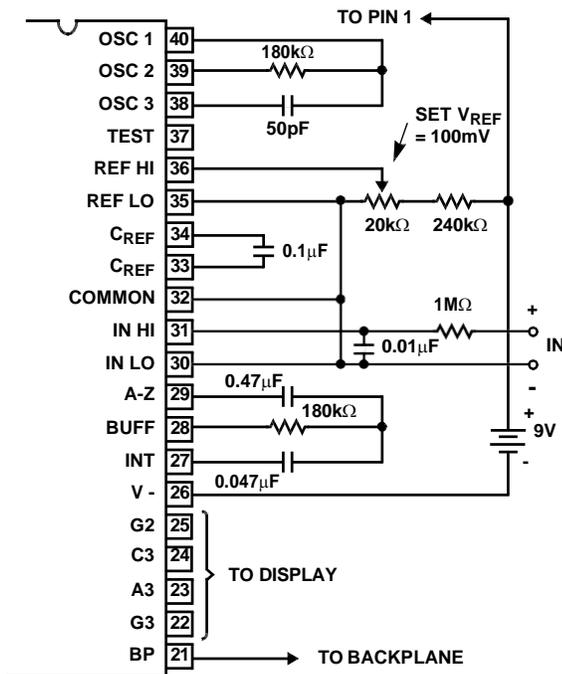
Typical Applications

The HT7126A may be used in a wide variety of configurations. The circuits which follow show some of the possibilities, and serve to illustrate the exceptional versatility of these A/D converters.

The following application notes contain very useful information on understanding and applying this part and are available from Intersil.

Application Notes

NOTE #	DESCRIPTION
AN016	"Selecting A/D Converters"
AN017	"The Integrating A/D Converter"
AN018	"Do's and Don'ts of Applying A/D Converters"
AN023	"Low Cost Digital Panel Meter Designs"
AN032	"Understanding the Auto-Zero and Common Mode Performance of the ICL7136/7/9 Family"
AN046	"Building a Battery-Operated Auto Ranging DVM with the ICL7106"
AN052	"Tips for Using Single Chip 3 ¹ / ₂ Digit A/D Converters"



Values shown are for 200mV full scale, 3 readings/sec., floating supply voltage (9V battery).

FIGURE 8. HT7126A USING THE INTERNAL REFERENCE

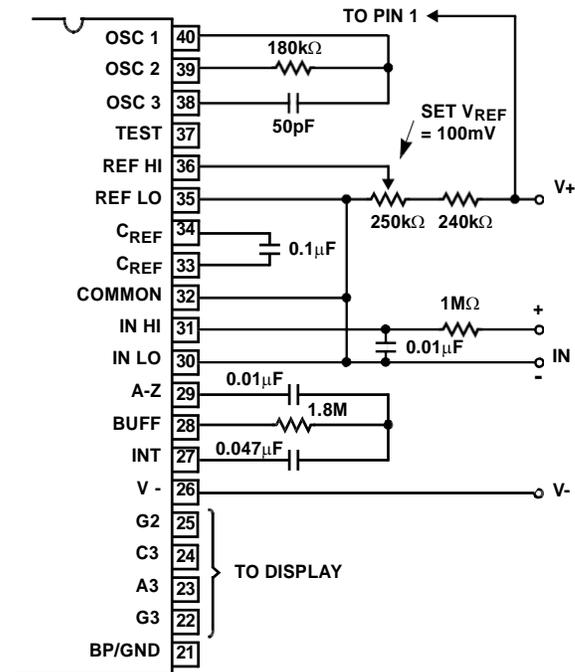
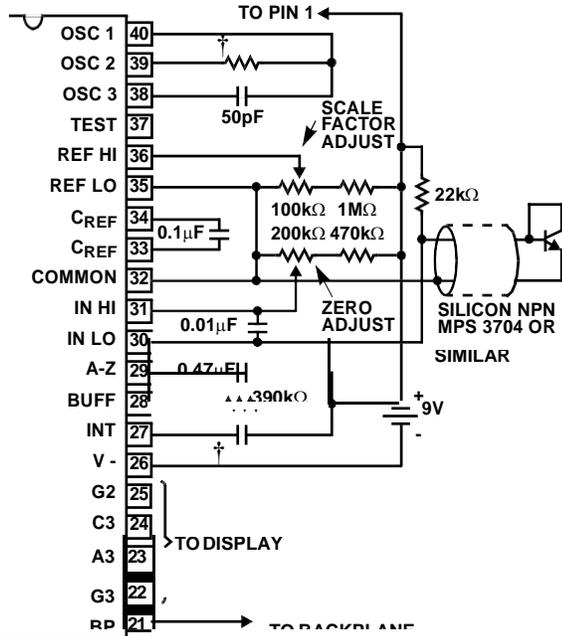


FIGURE 9. RECOMMENDED COMPONENT VALUES FOR 2V FULL SCALE



A silicon diode-connected transistor has a temperature coefficient of about $-2\text{mV}/^\circ\text{C}$. Calibration is achieved by placing the sensing transistor in ice water and adjusting the zeroing potentiometer for a 000.0 reading. The sensor should then be placed in boiling water and the scale-factor potentiometer adjusted for a 100.0 reading.
 † Value depends on clock frequency.

FIGURE 10. HT7126A USED AS A DIGITAL CENTIGRADE THERMOMETER

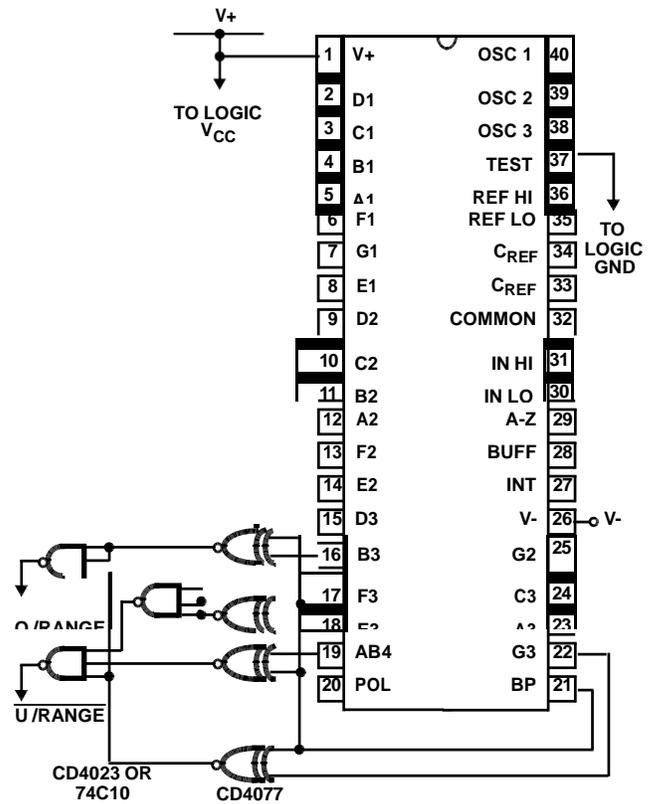
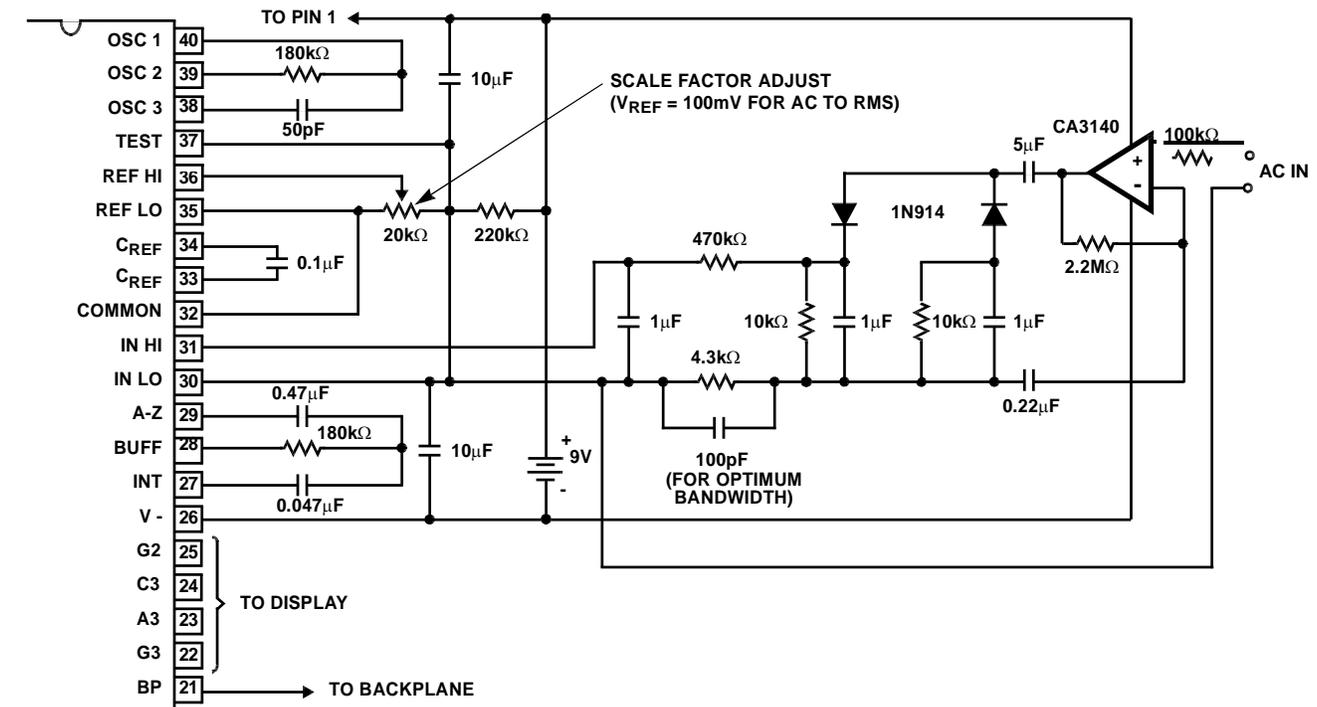
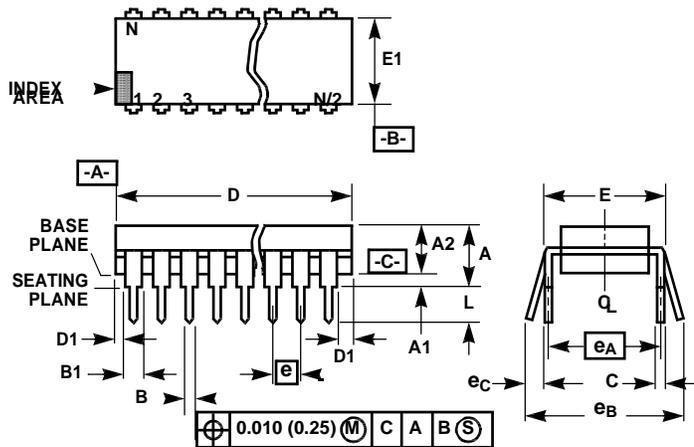


FIGURE 11. CIRCUIT FOR DEVELOPING UNDER-RANGE AND OVERRANGE SIGNAL FROM HT7126A OUTPUTS



Test is used as a common-mode reference level to ensure compatibility with most op amps.

FIGURE 12. AC TO DC CONVERTER WITH HT7126A

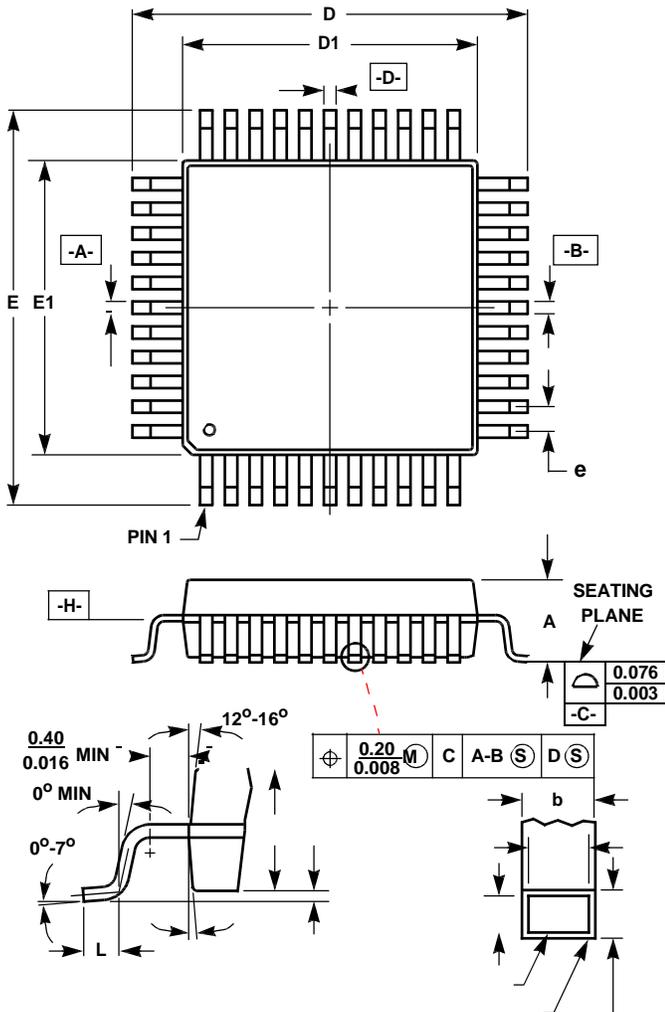
Dual-In-Line Plastic Packages (PDIP)

NOTES:

- Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
- Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication No. 95.
- Dimensions A, A1 and L are measured with the package seated in JEDEC seating plane gauge GS-3.
- D, D1, and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 inch (0.25mm).
- E and e_A are measured with the leads constrained to be perpendicular to datum $-C-$.
- e_B and e_C are measured at the lead tips with the leads unconstrained. e_C must be zero or greater.
- B1 maximum dimensions do not include dambar protrusions. Dambar protrusions shall not exceed 0.010 inch (0.25mm).
- N is the maximum number of terminal positions.
- Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3, E42.6 will have a B1 dimension of 0.030 - 0.045 inch (0.76 - 1.14mm).

**E40.6 (JEDEC MS-011-AC ISSUE B)
40 LEAD DUAL-IN-LINE PLASTIC PACKAGE**

SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	-	0.250	-	6.35	4
A1	0.015	-	0.39	-	4
A2	0.125	0.195	3.18	4.95	-
B	0.014	0.022	0.356	0.558	-
B1	0.030	0.070	0.77	1.77	8
C	0.008	0.015	0.204	0.381	-
D	1.980	2.095	50.3	53.2	5
D1	0.005	-	0.13	-	5
E	0.600	0.625	15.24	15.87	6
E1	0.485	0.580	12.32	14.73	5
e	0.100 BSC		2.54 BSC		-
e_A	0.600 BSC		15.24 BSC		6
e_B	-	0.700	-	17.78	7
L	0.115	0.200	2.93	5.08	4
N	40		40		9

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Metric Plastic Quad Flatpack Packages (MQFP)

**Q44.10x10 (JEDEC MS-022AB ISSUE B)
 44 LEAD METRIC PLASTIC QUAD FLATPACK PACKAGE**

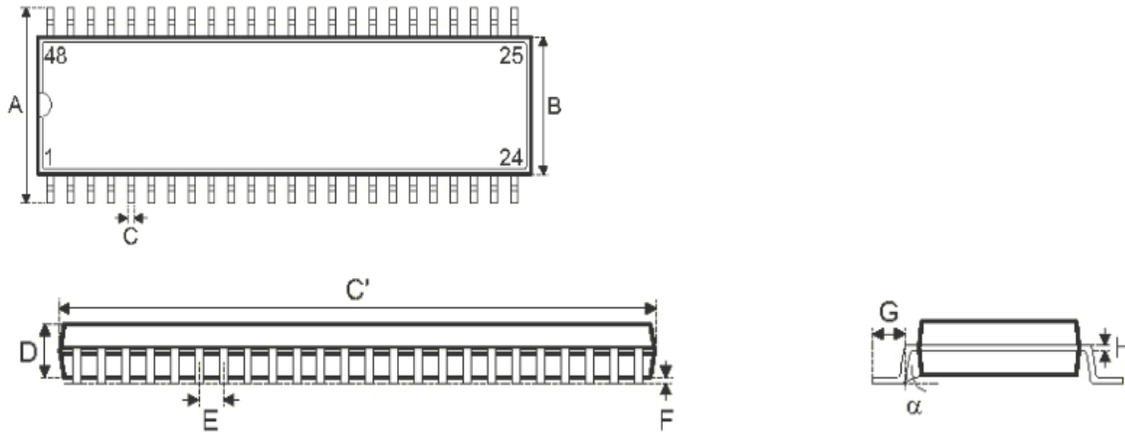
SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	-	0.096	-	2.45	-
A1	0.004	0.010	0.10	0.25	-
A2	0.077	0.083	1.95	2.10	-
b	0.012	0.018	0.30	0.45	6
b1	0.012	0.016	0.30	0.40	-
D	0.515	0.524	13.08	13.32	3
D1	0.389	0.399	9.88	10.12	4, 5
E	0.516	0.523	13.10	13.30	3
E1	0.390	0.398	9.90	10.10	4, 5
L	0.029	0.040	0.73	1.03	-
N	44		44		7
e	0.032 BSC		0.80 BSC		-

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NOTES:

1. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.
2. All dimensions and tolerances per ANSI Y14.5M-1982.
3. Dimensions D and E to be determined at seating plane -C-.

Package Information
48-pin SSOP (300mil) Outline Dimensions



Symbol	Dimensions in mil		
	Min.	Nom.	Max.
A	395	—	420
B	291	—	299
C	8	—	12
C'	613	—	637
D	85	—	99
E	—	25	—
F	4	—	10
G	25	—	35
H	4	—	12
α	0°	—	8°

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